

NEO series: HS-SODIMM-S1

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Introduction

Hiksemi memory module S1 is a DDR3 memory module, which is made of original high-quality particles and mature production technology, which makes it more compatible, stable and cost-effective. Can be widely used in PC installations, various high-bandwidth, high-performance system applications



Features

Cost-effective

Adopt original granules to make the system run stably and perform better

Good compatibility

Better compatibility, compatible with more products after Hikvision optimization

Ordering Information

Capacity	Model
4GB	HSC304S16A01Z1
8GB	HSC308S16A01Z1



Please contact the local sales for detailed model information.



Specification

Name	HS-SODIMM-S1		
Capacity	4GB	8GB	
Interface	DDR3		
frequency	1600MHz		
Pin	204pin		
Size(L×W×H mm)	70*30*1.3		
Operation temperature	0 °C to 85 °C (32 °F to 185 °F)		
Limited warranty period	Lifetime warranty		
Weight	8g		

Revision History

Version	Description	Date
V1.0.0	NEO series: HS-SODIMM-S1	20220303
V1.0.1	Slogan change	20220726

Data subject to change without notice.

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